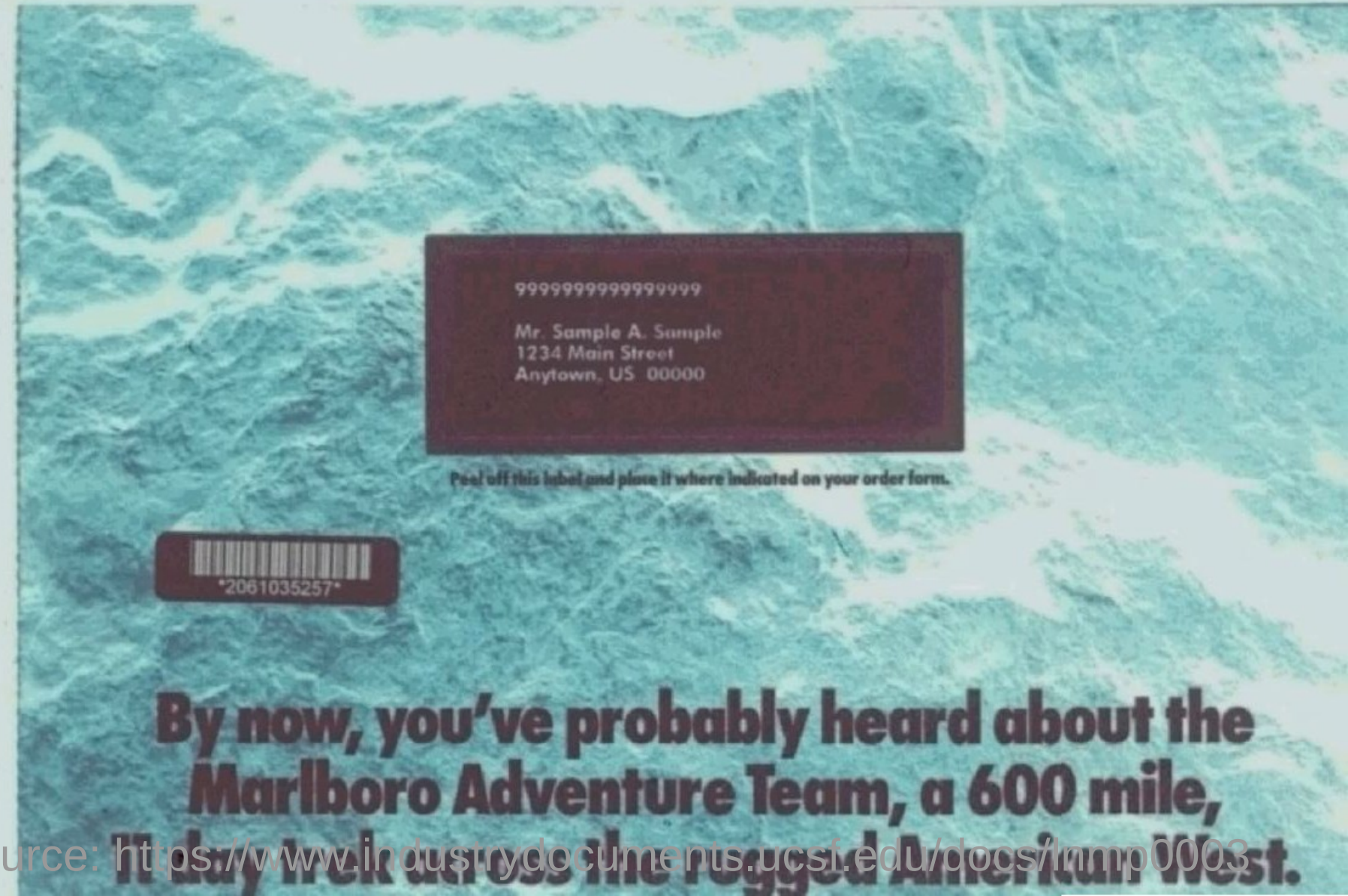

Source: https://www.industrydocuments.ucsf.edu/docs/lnmp0003

2061035257